



P/N: HY160808 SRF07

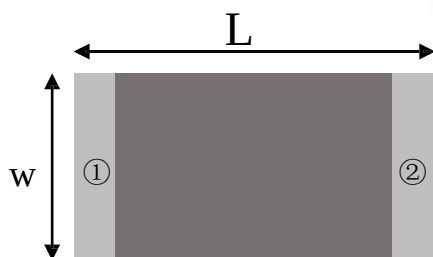
Features

1. Surface mounted devices with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beautifying the housing of final product.
3. High stability and low tolerance.

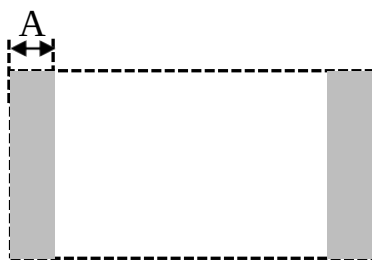
Applications

1. Bluetooth
2. Wireless LAN
3. ISM band 2.4GHz wireless applications

Dimensions (Unit: mm)



(Top View)



(Bottom View)

Number	Terminal Name
①	INPUT
②	NC



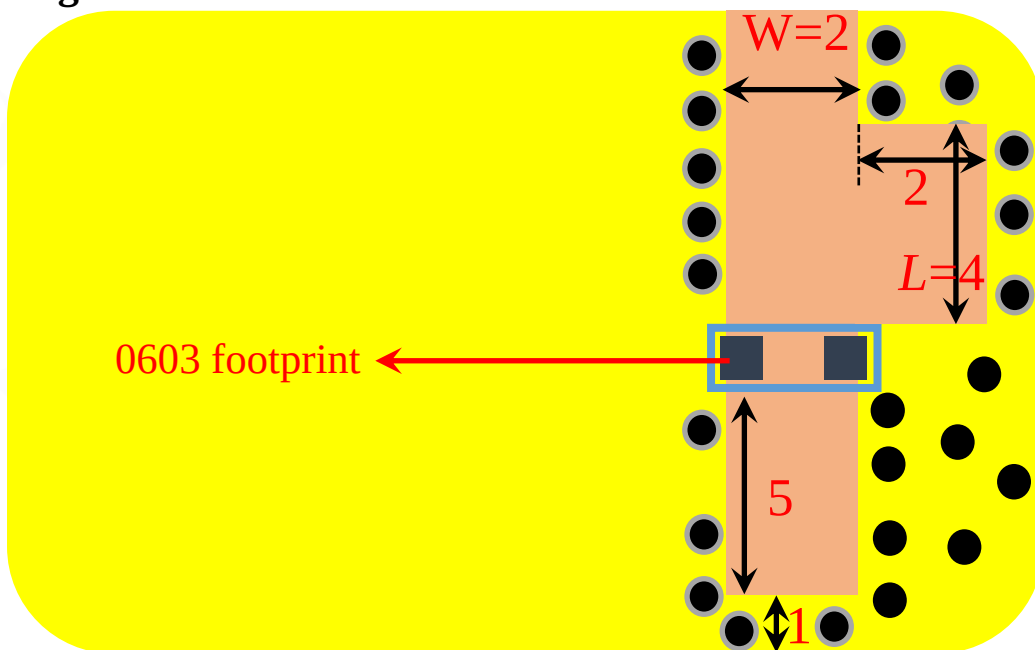
(Side View)

Symbols	L	W	T	A
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10

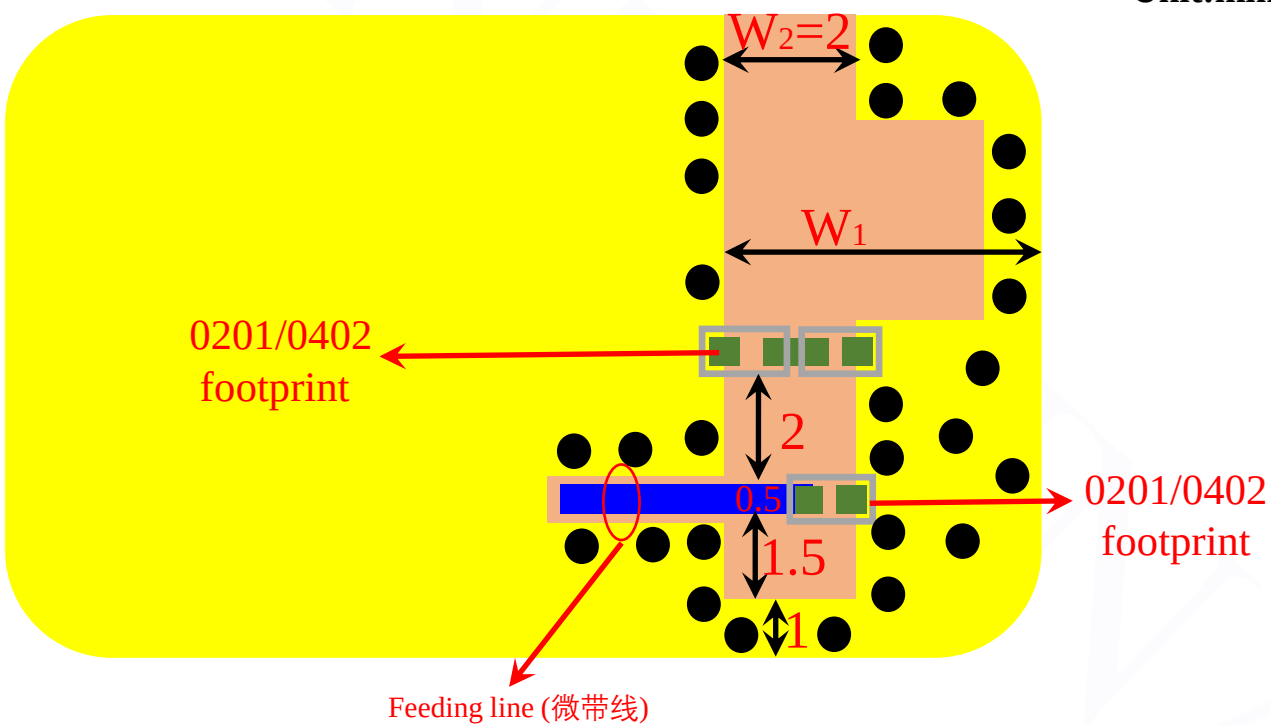


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Matching Circuits



Unit:mm



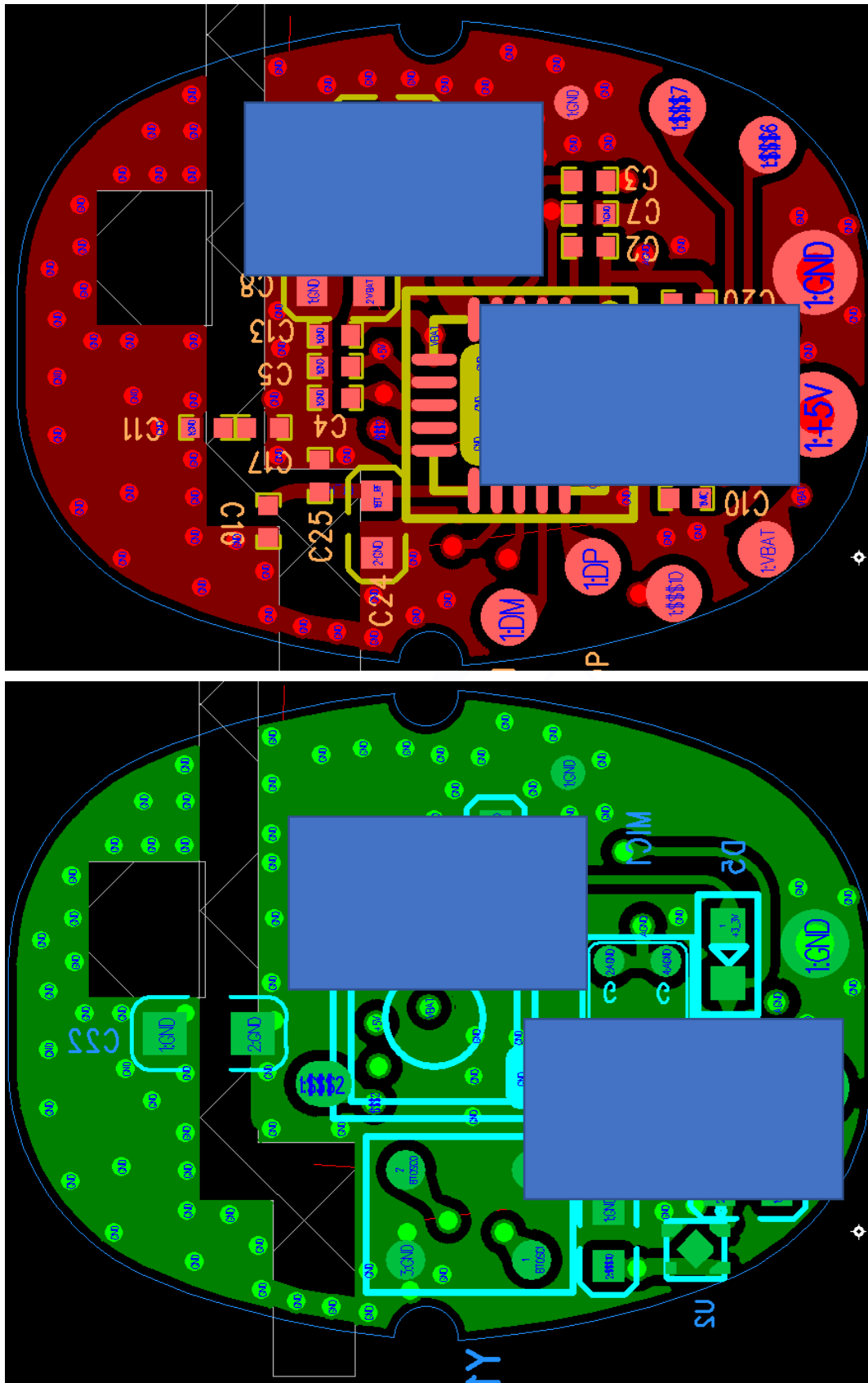
设计指导:

- 1、原则上，净空区左侧边缘距离板边的间距 W_1 应该尽量大，且注意与底部电池的间距。
- 2、主净空区的宽度 W_2 最优为1.5mm~2.5mm。
- 3、凹槽的长度 L 的长度为2mm~5mm。
- 4、0603天线和0603天线底部的两颗物料可以上下互换位置。



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Application example-1

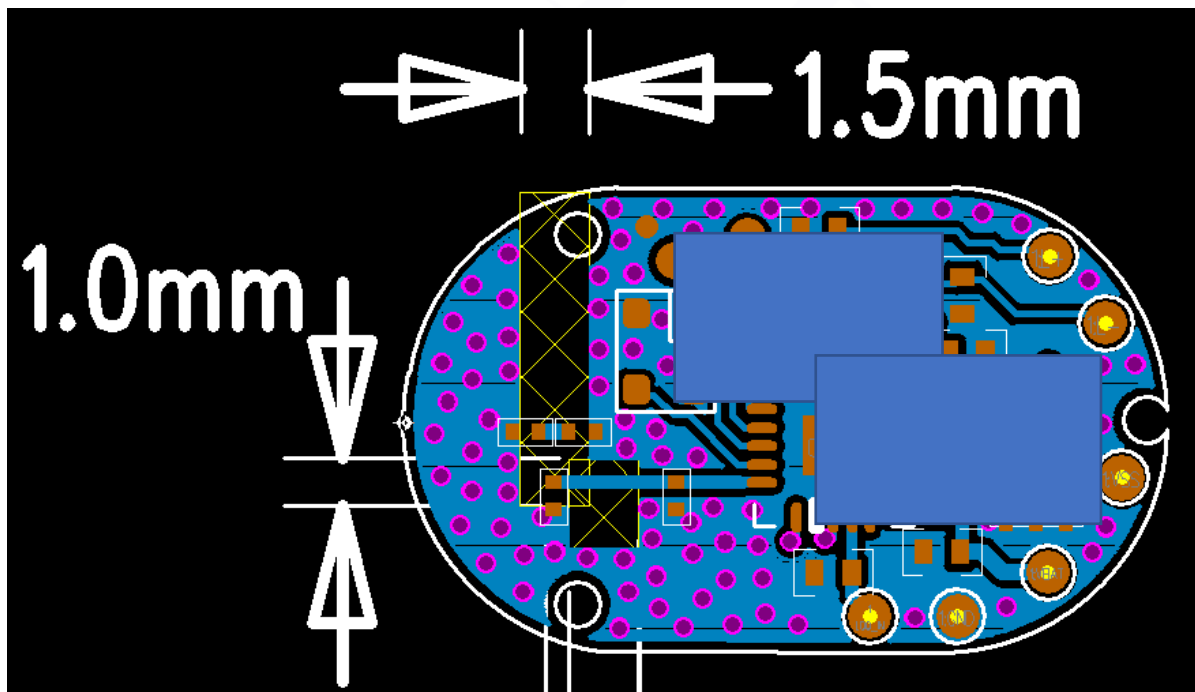


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Application example-2



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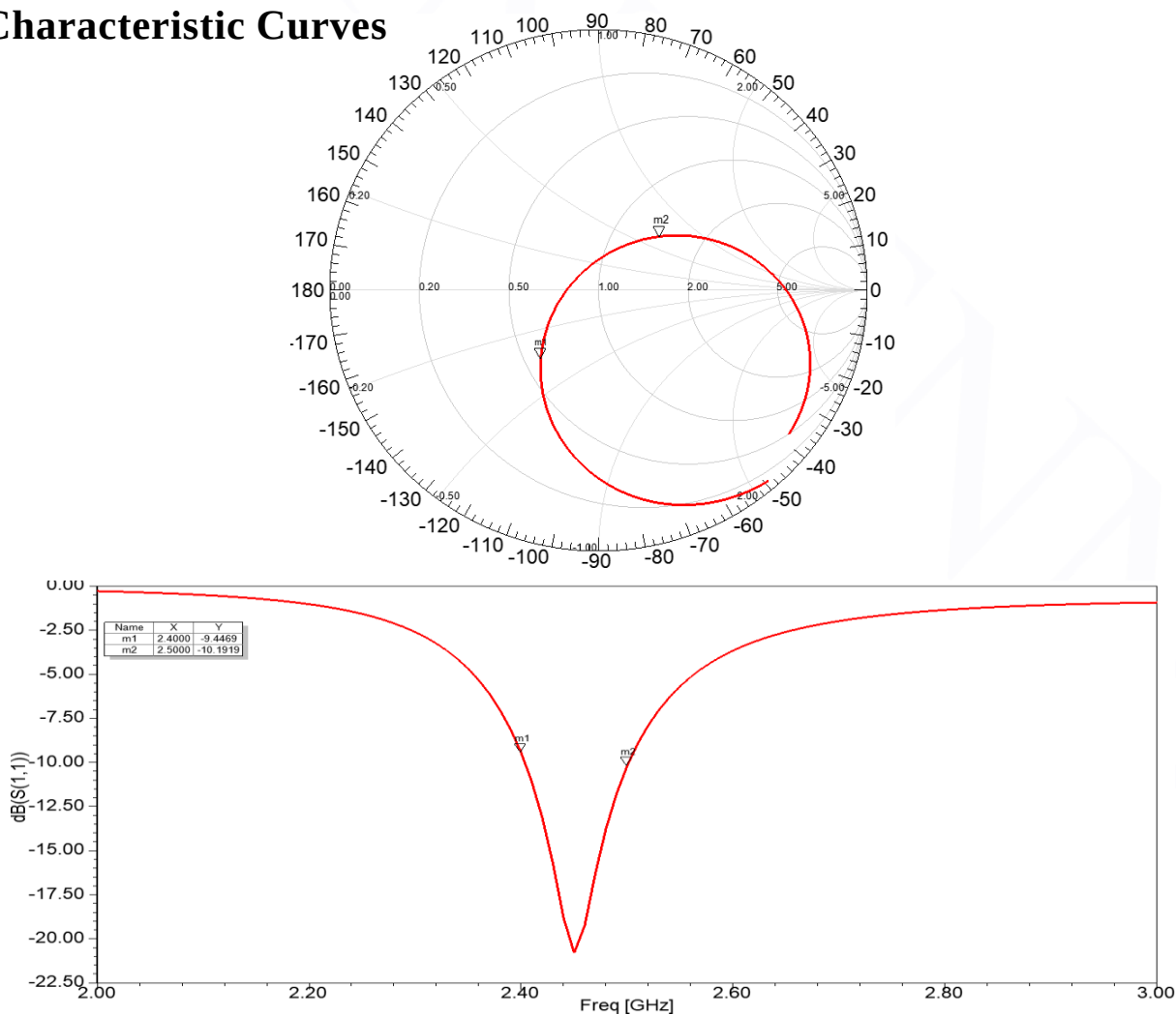


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Electrical Characteristics

	Feature	Specification
1	Central frequency	2.45GHz&5.5GHz
2	Bandwidth	>100MHz
3	Peak gain	3dBi
4	VSWR	<2
5	Polarization	Linear
6	Azimuth beamwidth	Omnidirectional
7	Impedance	50 Ω

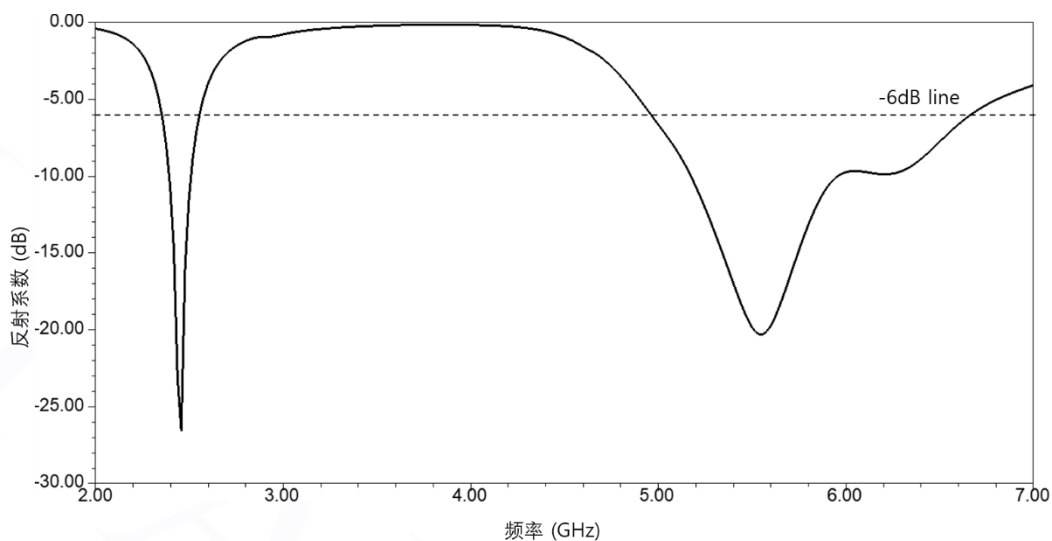
Characteristic Curves



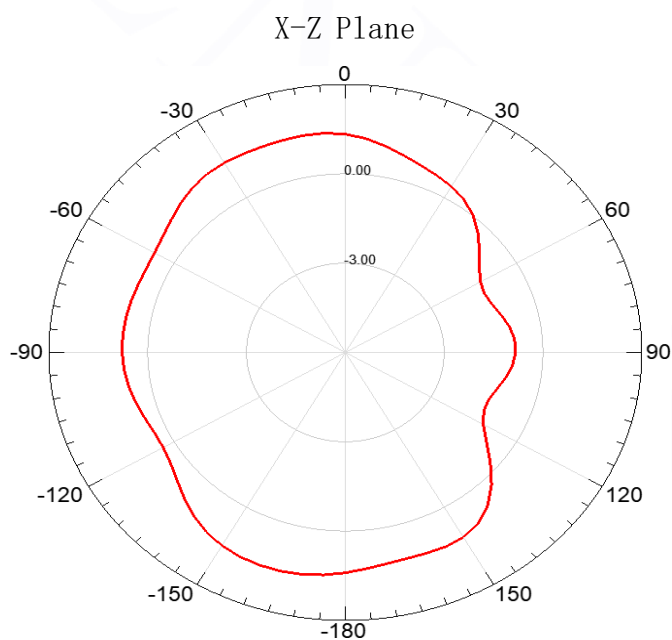
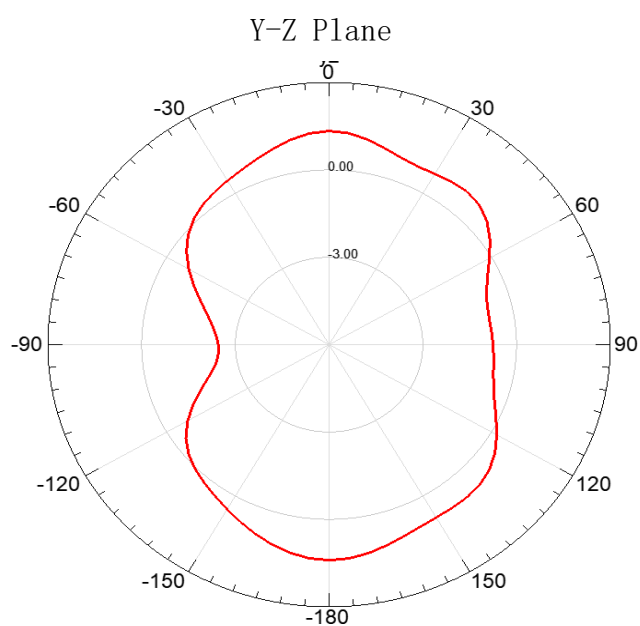
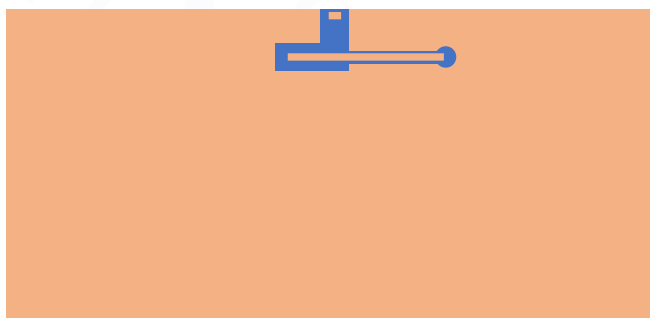
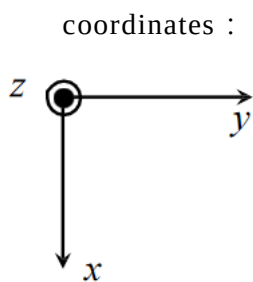
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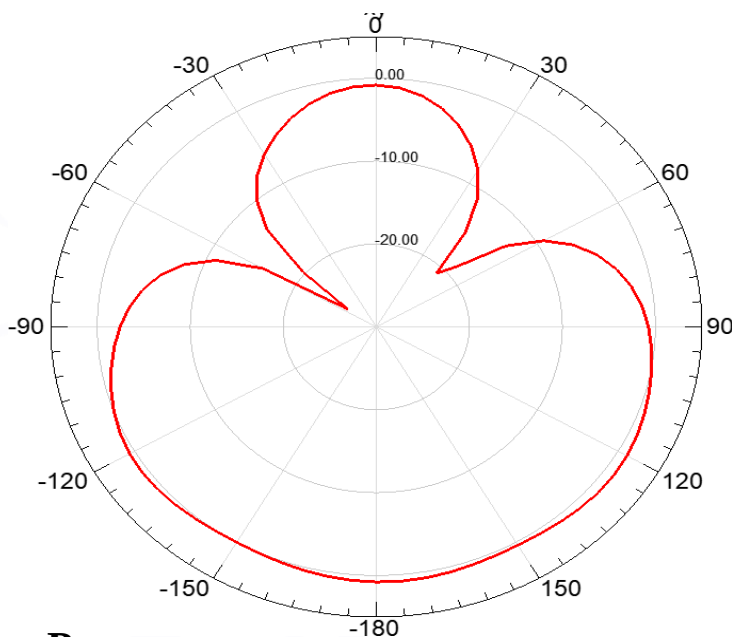


Radiation Pattern

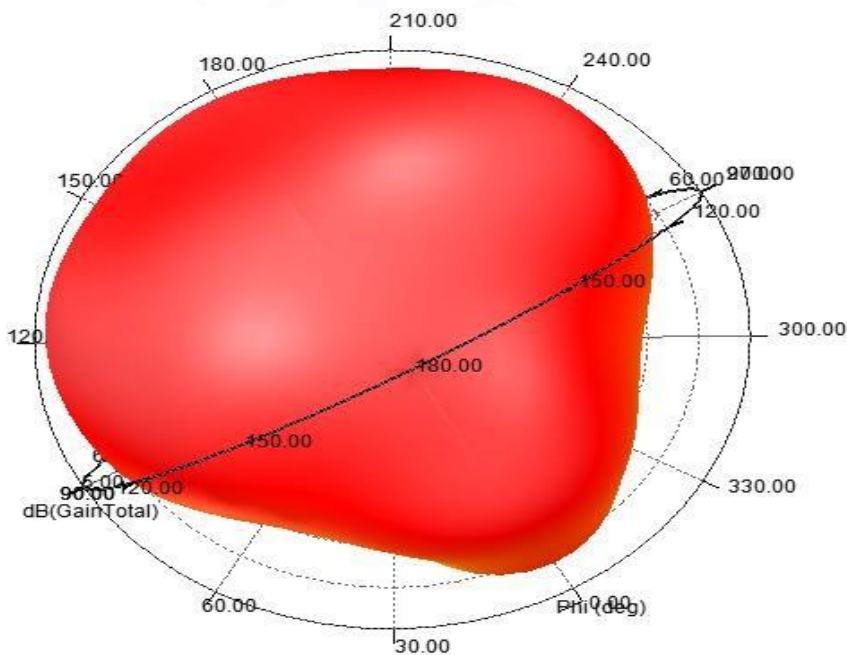




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3D Radiation Pattern



Frequency	2450MHz	5500MHz
Avg. gain	-0.85	-1.30
Peak gain	3.0	2.5
Efficiency	82%	78%



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Dependability Test

Test Temperature	$25^{\circ}\text{C} \pm 3^{\circ}\text{C}$
Operating Temperature	$-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$
Temperature	$5 \sim 40^{\circ}\text{C}$
Relative Humidity	20~70%

Moisture Proof

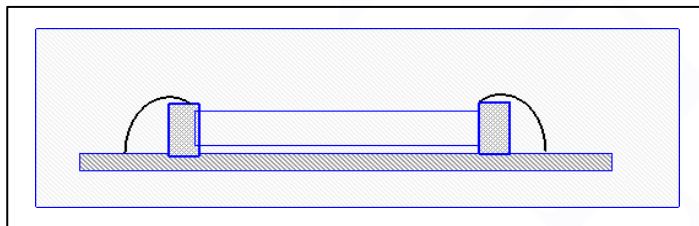
Temperature: $40 \pm 2^{\circ}\text{C}$ Humidity: 90~95%RH
Duration: 500h
Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

Solderability

At least 95% of the terminal electrode is covered by new solder.
Preheating conditions: 80 to 120°C ; 10~30s.
Solder Temperature: $235 \pm 5^{\circ}\text{C}$ Duration: $2 \pm 0.5\text{s}$, Solder Temperature: $245 \pm 5^{\circ}\text{C}$ Duration: $2 \pm 0.5\text{s}$

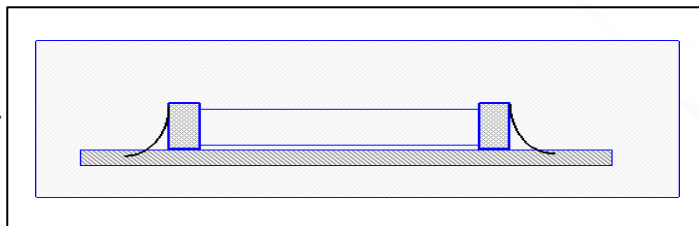
Optimum Solder Amount for Reflow Soldering

Too much solder



Cracks tend to occur due to large stress.

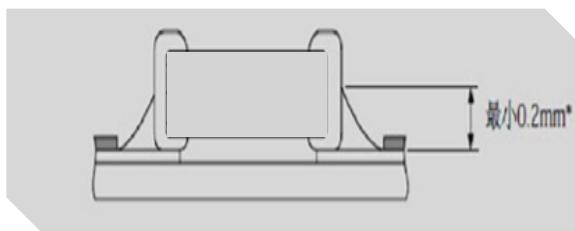
Not enough solder



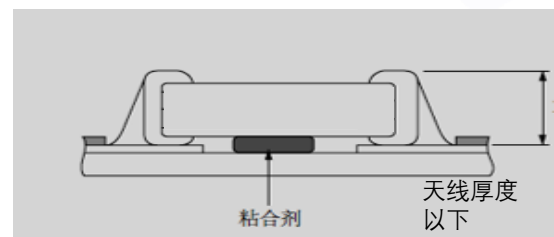
Weak holding force may cause bad connection between the chip and PCB.

Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering





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Temperature Cycle Test

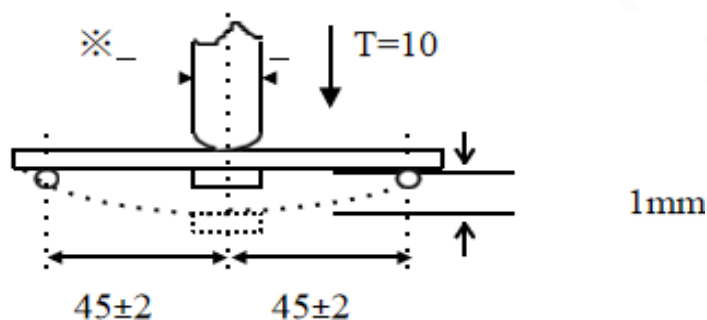
10±1S Applied Force: 5N Duration: 10±1S
Preheating conditions: up-category temperature, 1h
Recovery time: 24±1h
Initial Measurement
Cycling Times: 5 times, 1 cycle, 4 steps:

阶段	温度 (°C)	时间 (分钟)
第1步	下限温度(NPO/X7R/X7S/X6S/X5R:-55 Y5V:-25 Z5U:+10)	30
第2步	常温 (+20)	2~3
第3步	上限温度(NPO/X7R/X7S: +125 Y5V/Z5U/X5R:-85 X6S:-105)	30
第4步	常温 (+20)	2~3

Resistance to Soldering Heat

Preheating 80 to 120°C; 10~30s.Solder Temperature: 235±5°C; Duration: 2±0.5s; Solder Temperature: 245±5°C
Duration: 2±0.5s; Preheating 100 to 200°C; 10±2min.
Solder Temperature: 265±5°C; Duration: 10±1s
Clean the capacitor with solvent and examine it with a 10X(min.) microscope.
Recovery Time: 24±2h
Recovery condition: Room temperature

Resistance to Flexure of Substrate



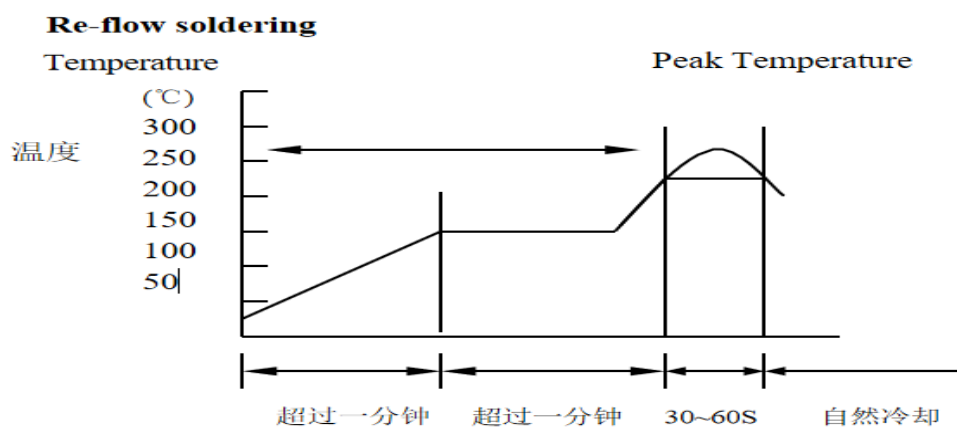
Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec.
Unit: mm

The measurement should be made with the board in the bending position.



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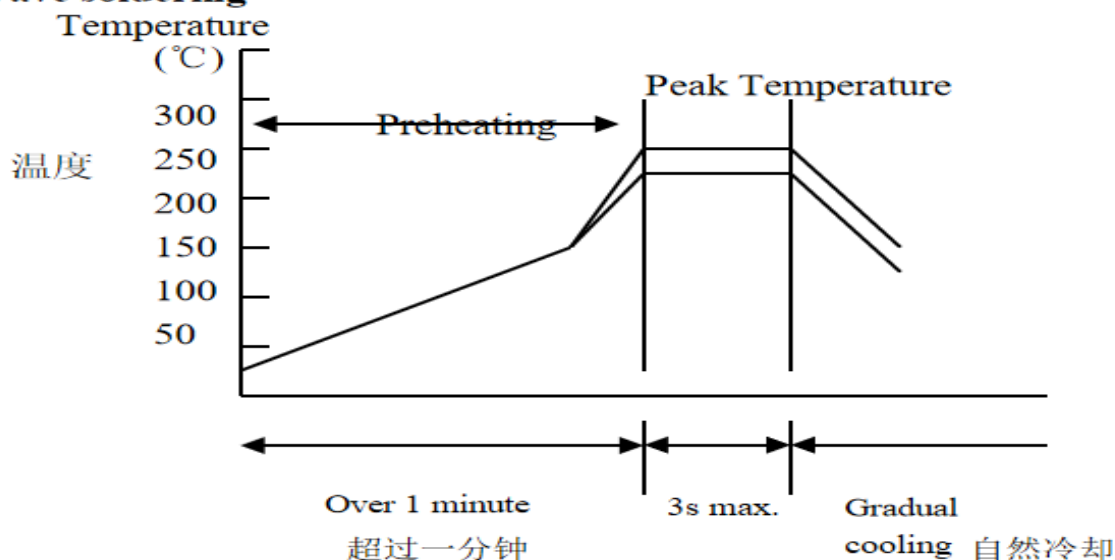
The temperature profile for soldering



	Pb-Sn 焊接 Pb-Sn soldering	无铅焊接 Lead-free soldering
尖峰温度 Peak temperature	230℃~250℃	240℃~260℃

While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: $T \leq 150^{\circ}\text{C}$.

Wave soldering

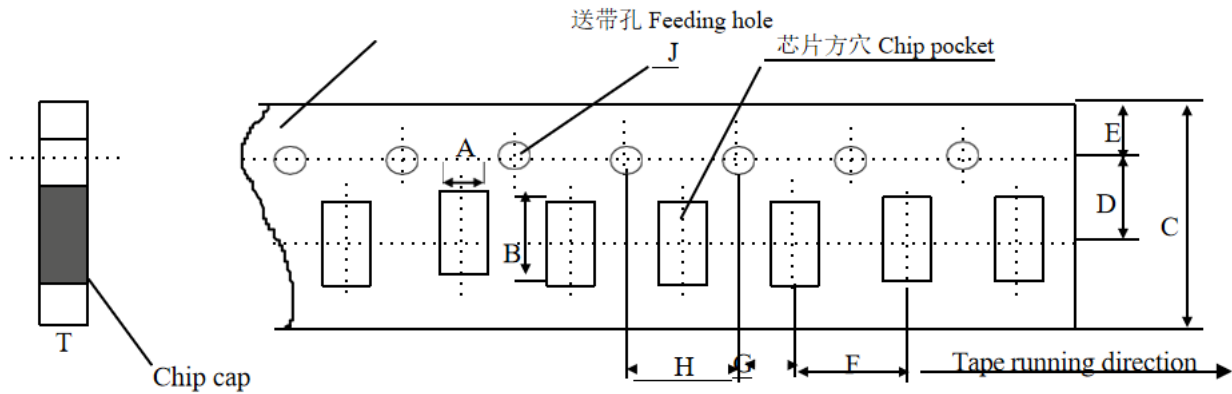


	Pb-Sn 焊接 Pb-Sn soldering	无铅焊接 Lead-free soldering
尖峰温度 Peak temperature	230℃~260℃	240℃~270℃



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Dimensions of paper taping

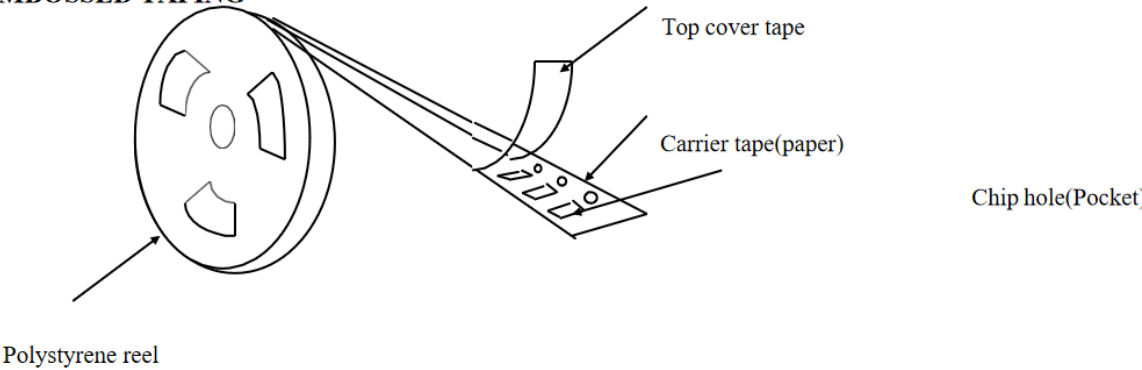


Unit: mm

代号Code 纸带规格 papersize	A	B	C	D*	E	F	G*	H	J	T
尺寸	1.10 ±0.10	1.90 ±0.10	8.00 ±0.10	3.50 ±0.05	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	4.00 ±0.10	1.50 -0/+0.10	1.10 Max

Reel (4000 pcs/Reel)

EMBOSED TAPING



Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition).
Temperature:5~40°C /Relative Humidity:20~70%

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